

3V MICROPOWER DUAL CMOS VOLTAGE COMPARATORS

- DEDICATED TO 3.3V OR BATTERY SUPPLY
(specified at 3V and 5V)
- PUSH-PULL CMOS OUTPUT (NO EXTERNAL PULL-UP RESISTOR REQUIRED)
- EXTREMELY LOW SUPPLY CURRENT :
7µA typ / comparator
- WIDE SINGLE SUPPLY RANGE
2.7V TO 16V
- EXTREMELY LOW INPUT CURRENTS :
1pA typ
- INPUT COMMON-MODE VOLTAGE RANGE
INCLUDES GND
- FAST RESPONSE TIME : 2µs typ for
5mV overdrive
- PIN-TO-PIN AND FUNCTIONALLY
COMPATIBLE WITH BIPOLAR LM393

DESCRIPTION

The TS3V3702 is a micropower dual CMOS voltage comparator with extremely low consumption of 7µA typ / comparator (20 times less than bipolar LM393). The push-pull CMOS output stage allows power and space saving by eliminating the external pull-up resistor required by usual open-collector output comparators.

Thus response times remain similar to the LM393.

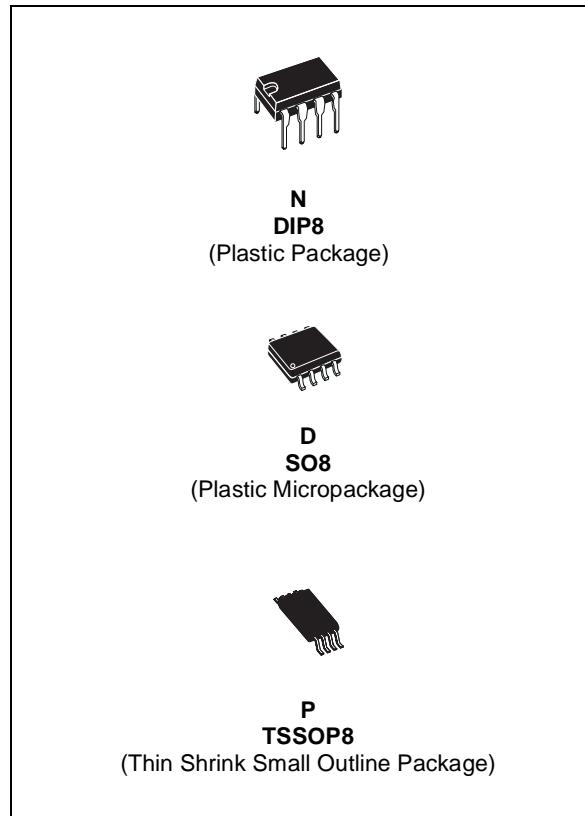
ORDER CODE

Part Number	Temperature Range	Package		
		N	D	P
TS3V3702I	-40°C, +125°C	•	•	•

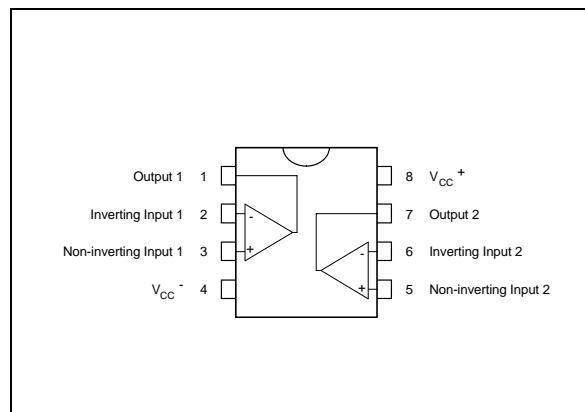
N = Dual in Line Package (DIP)

D = Small Outline Package (SO) - also available in Tape & Reel (DT)

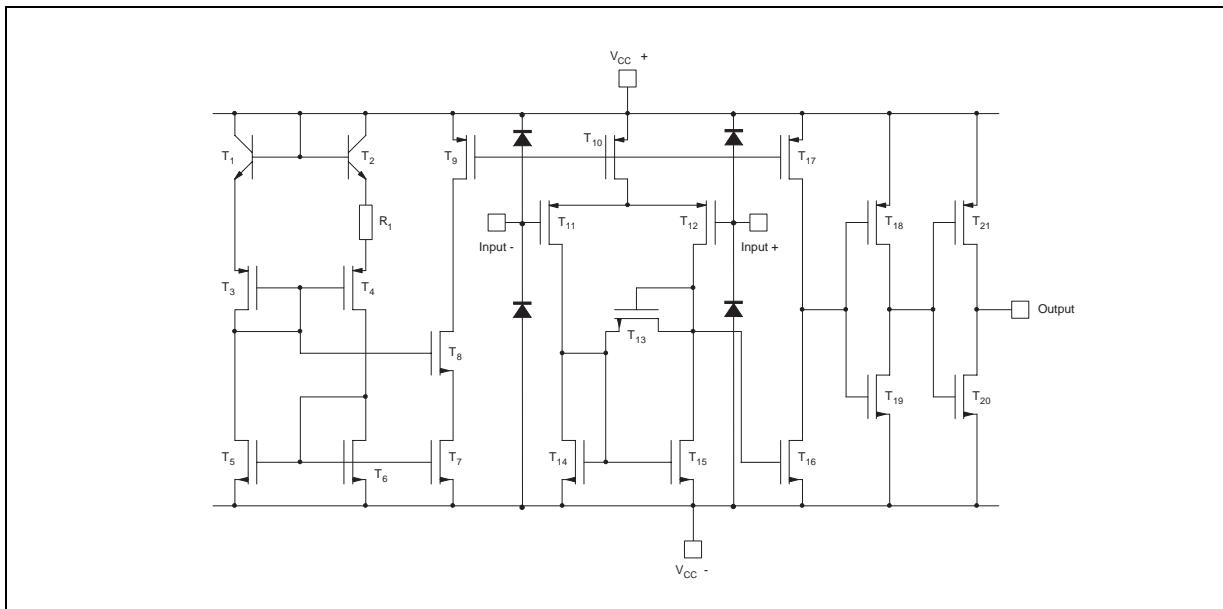
P = Thin Shrink Small Outline Package (TSSOP) - only available in Tape & Reel (PT)



PIN CONNECTIONS (top view)



SCHEMATIC DIAGRAM (for 1/2 TS3V3702)



ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter	Value	Unit
V_{CC}^+	Supply Voltage ¹⁾	18	V
V_{id}	Differential Input Voltage ²⁾	± 18	V
V_i	Input Voltage ³⁾	18	V
V_o	Output Voltage	18	V
I_o	Output Current	20	mA
I_F	Forward Current in ESD Protection Diodes on Input ⁴⁾	50	mA
P_d	Power Dissipation ⁵⁾ DIP8 SO8 TSSOP8	1250 710 625	mW
T_{stg}	Storage Temperature Range	-65 to +150	°C

1. All voltage values, except differential voltage, are with respect to network ground terminal.
2. Differential voltages are the non-inverting input terminal with respect to the inverting input terminal.
3. The magnitude of the input and the output voltages must never exceed the magnitude of the positive supply voltage.
4. Guaranteed by design.
5. P_d is calculated with $T_{amb} = +25^\circ\text{C}$, $T_j = +150^\circ\text{C}$ and $R_{thja} = 100^\circ\text{C/W}$ for DIP8 package
 $= 175^\circ\text{C/W}$ for SO8 package
 $= 200^\circ\text{C/W}$ for TSSOP8 package

OPERATING CONDITIONS

Symbol	Parameter	Value	Unit
V_{CC}^+	Supply Voltage	2.7 to 16	V
V_{icm}	Common Mode Input Voltage Range	0 to $V_{CC}^+ - 1.5$	V
T_{oper}	Operating Free-Air Temperature range	-40 to +125	°C

ELECTRICAL CHARACTERISTICS $V_{CC}^+ = 3V$, $V_{CC}^- = 0V$, $T_{amb} = 25^\circ C$ (unless otherwise specified)

Symbol	Parameter	Min.	Typ.	Max.	Unit
V_{io}	Input Offset Voltage ¹⁾ $V_{ic} = 1.5V$ $T_{min} \leq T_{amb} \leq T_{max}$.			5 6.5	mV
I_{io}	Input Offset Voltage ²⁾ $V_{ic} = 1.5V$ $T_{min} \leq T_{amb} \leq T_{max}$.		1	300	pA
I_{ib}	Input Bias Current (see note 2) $V_{ic} = 1.5V$ $T_{min} \leq T_{amb} \leq T_{max}$.		1	600	pA
V_{icm}	Input Common Mode Voltage Range $T_{min} \leq T_{amb} \leq T_{max}$	0 0		$V_{CC}^+ - 1.2$ $V_{CC}^+ - 1.5$	V
CMR	Common-mode Rejection Ratio $V_{ic} = V_{icm}$ min.		80		dB
SVR	Supply Voltage Rejection Ratio $V_{CC}^+ = 3V$ to $5V$		75		dB
V_{OH}	High Level Output Voltage $V_{id} = 1V$, $I_{OH} = -4mA$ $T_{min} \leq T_{amb} \leq T_{max}$.	2 1.8	2.4		V
V_{OL}	Low Level Output Voltage $V_{id} = -1V$, $I_{OL} = 4mA$ $T_{min} \leq T_{amb} \leq T_{max}$.		300	400 450	mV
I_{CC}	Supply Current (each comparator) No load - Outputs low $T_{min} \leq T_{amb} \leq T_{max}$.		7	20 25	μA
t_{PLH}	Response Time Low to High $V_{ic} = 0V$, $f = 10kHz$, $C_L = 50pF$, Overdrive = 5mV TTL Input		1.5 0.7		μs
t_{PHL}	Response Time High to Low $V_{ic} = 0V$, $f = 10kHz$, $C_L = 50pF$, Overdrive = 5mV TTL Input		2.2 0.15		μs

1. The specified offset voltage is the maximum value required to drive the output up to 4.5V or down to 0.3V.

2. Maximum values including unavoidable inaccuracies of the industrial test.

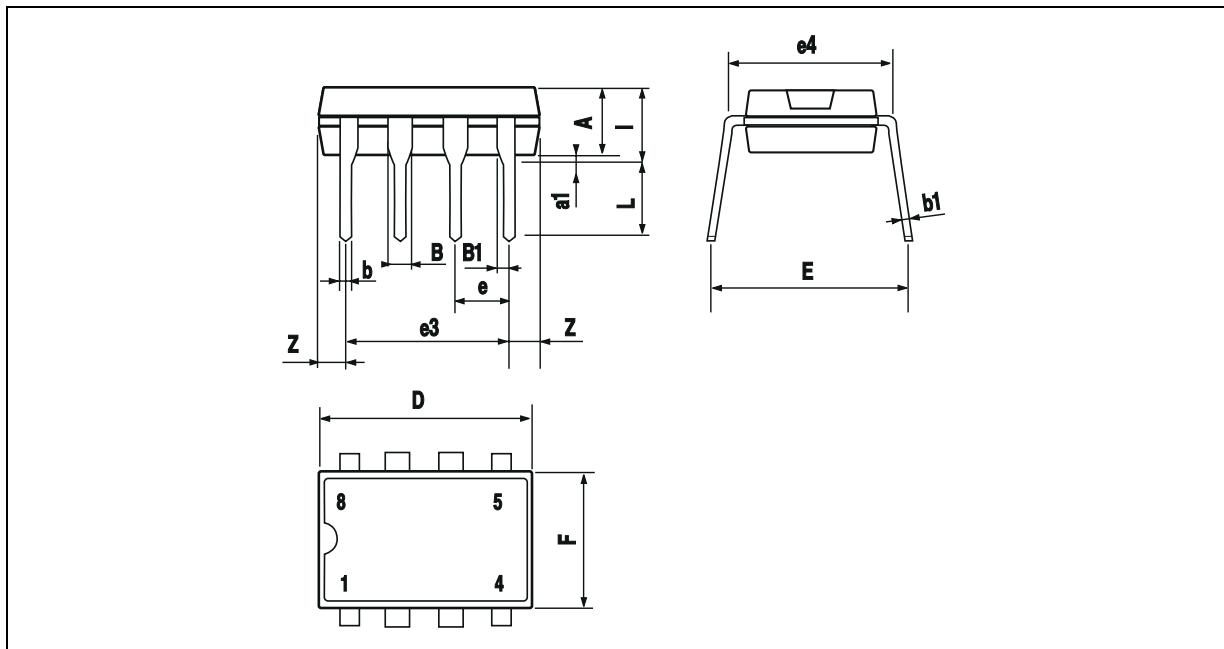
ELECTRICAL CHARACTERISTICS $V_{CC}^+ = 5V$, $V_{CC}^- = 0V$, $T_{amb} = 25^\circ C$ (unless otherwise specified)

Symbol	Parameter	Min.	Typ.	Max.	Unit
V_{io}	Input Offset Voltage ¹⁾ $V_{ic} = 2.5V$ $T_{min} \leq T_{amb} \leq T_{max}$.		1.2	5 6.5	mV
I_{io}	Input Offset Current ²⁾ $V_{ic} = 2.5V$ $T_{min} \leq T_{amb} \leq T_{max}$.		1	300	pA
I_{ib}	Input Bias Current (see note 2) $V_{ic} = 2.5V$ $T_{min} \leq T_{amb} \leq T_{max}$.		1	600	pA
V_{icm}	Input Common Mode Voltage Range $T_{min} \leq T_{amb} \leq T_{max}$	0 0		$V_{CC}^+ - 1.2$ $V_{CC}^+ - 1.5$	V
CMR	Common-mode Rejection Ratio $V_{ic} = V_{icm}$ min.		82		dB
SVR	Supply Voltage Rejection Ratio $V_{CC}^+ = +5V$ to $+10V$		90		dB
V_{OH}	High Level Output Voltage $V_{id} = 1V$, $I_{OH} = -4mA$ $T_{min} \leq T_{amb} \leq T_{max}$.	4.5 4.3	4.7		V
V_{OL}	Low Level Output Voltage $V_{id} = -1V$, $I_{OL} = 4mA$ $T_{min} \leq T_{amb} \leq T_{max}$.		200	300 375	mV
I_{CC}	Supply Current (each comparator) No load - Outputs low $T_{min} \leq T_{amb} \leq T_{max}$.		9	20 25	µA
t_{PLH}	Response Time Low to High $V_{ic} = 0V$, $f = 10kHz$, $C_L = 50pF$, Overdrive = 5mV Overdrive = 10mV Overdrive = 20mV Overdrive = 40mV TTL Input		1.5 1.1 0.9 0.7 0.6		µs
t_{PHL}	Response Time High to Low $V_{ic} = 0V$, $f = 10kHz$, $C_L = 50pF$, Overdrive = 5mV Overdrive = 10mV Overdrive = 20mV Overdrive = 40mV TTL Input		2.2 1.6 1.1 0.75 0.17		µs
t_f	Fall time $f = 10kHz$, $C_L = 50pF$, Overdrive 50mV		30		ns

1. The specified offset voltage is the maximum value required to drive the output up to 4.5V or down to 0.3V.

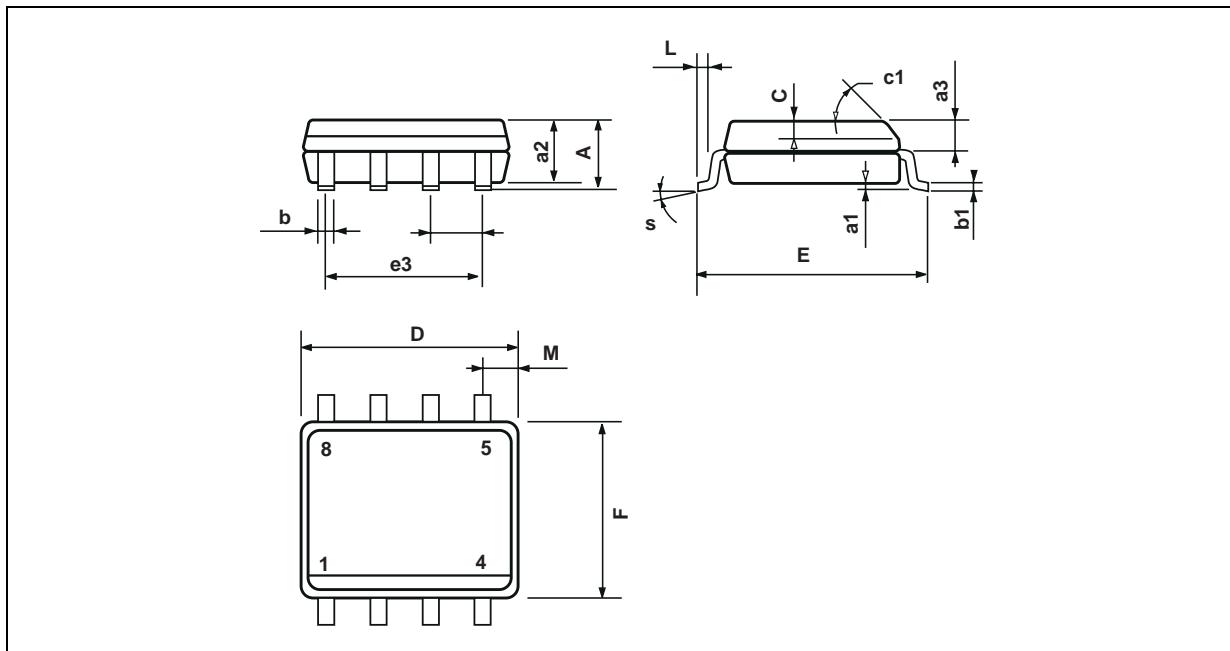
2. Maximum values including unavoidable inaccuracies of the industrial test.

PACKAGE MECHANICAL DATA
8 PINS - PLASTIC DIP



Dimensions	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A		3.32			0.131	
a1	0.51			0.020		
B	1.15		1.65	0.045		0.065
b	0.356		0.55	0.014		0.022
b1	0.204		0.304	0.008		0.012
D			10.92			0.430
E	7.95		9.75	0.313		0.384
e		2.54		0.100		
e3		7.62		0.300		
e4		7.62		0.300		
F			6.6			0.260
i			5.08			0.200
L	3.18		3.81	0.125		0.150
Z			1.52			0.060

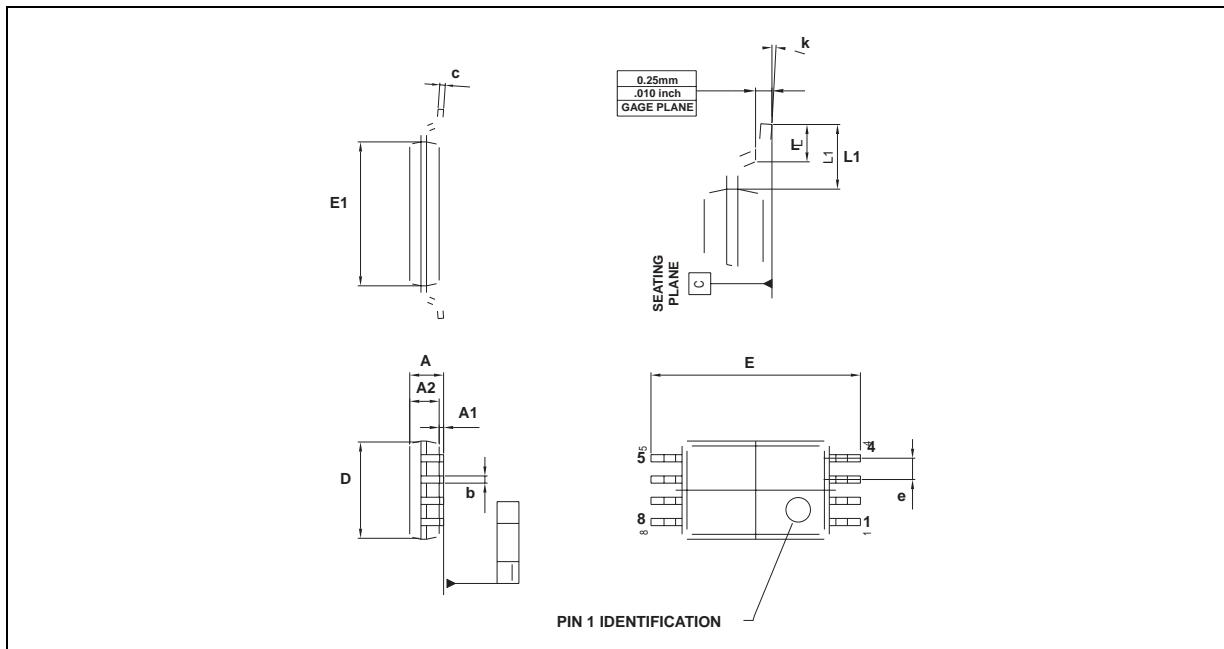
PACKAGE MECHANICAL DATA
8 PINS - PLASTIC MICROPACKAGE (SO)



Dimensions	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A			1.75			0.069
a1	0.1		0.25	0.004		0.010
a2			1.65			0.065
a3	0.65		0.85	0.026		0.033
b	0.35		0.48	0.014		0.019
b1	0.19		0.25	0.007		0.010
C	0.25		0.5	0.010		0.020
c1	45° (typ.)					
D	4.8		5.0	0.189		0.197
E	5.8		6.2	0.228		0.244
e		1.27			0.050	
e3		3.81			0.150	
F	3.8		4.0	0.150		0.157
L	0.4		1.27	0.016		0.050
M			0.6			0.024
S	8° (max.)					

PACKAGE MECHANICAL DATA

8 PINS - THIN SHRINK SMALL OUTLINE PACKAGE (TSSOP)



Dimensions	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A			1.20			0.05
A1	0.05		0.15	0.01		0.006
A2	0.80	1.00	1.05	0.031	0.039	0.041
b	0.19		0.30	0.007		0.15
c	0.09		0.20	0.003		0.012
D	2.90	3.00	3.10	0.114	0.118	0.122
E		6.40			0.252	
E1	4.30	4.40	4.50	0.169	0.173	0.177
e		0.65			0.025	
k	0°		8°	0°		8°
I	0.50	0.60	0.75	0.09	0.0236	0.030
L	0.45	0.600	0.75	0.018	0.024	0.030
L1		1.000			0.039	

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